



Vincotech

flow PACK 2

1200 V / 150 A

Features

- Trench Fieldstop IGBTs for low saturation losses
- Open emitter configuration
- Compact and low inductive design
- Integrated NTC

flow 2 17 mm housing



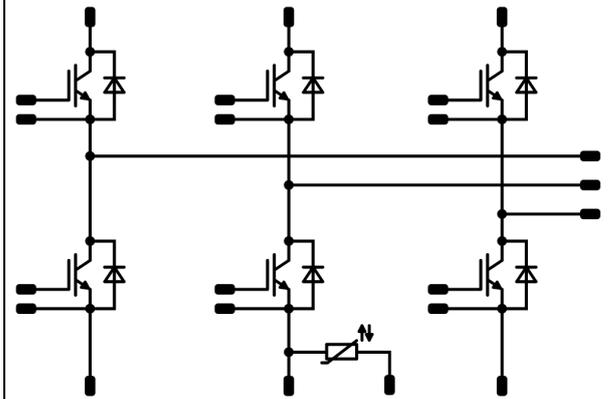
Target applications

- Industrial drives

Types

- 30-P2126PA150SC-L280F09Y

Schematic



Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------------------------------|------------|--|----------|-------------|
| Inverter Switch | | | | |
| Collector-emitter voltage | V_{CES} | | 1200 | V |
| Collector current | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 144 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 450 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 354 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Short circuit ratings | t_{SC} | $T_j \leq 150\text{ °C}$ | 10 | μs |
| | V_{CC} | $V_{GE} = 15\text{ V}$ | 800 | V |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}C$ |



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-------------------------------------|------------|--------------------------------------|-------|------|
| Inverter Diode | | | | |
| Peak Repetitive Reverse Voltage | V_{RRM} | | 1200 | V |
| Continuous (direct) forward current | I_F | $T_j = T_{jmax}$ $T_s = 80\text{°C}$ | 128 | A |
| Repetitive peak forward current | I_{FRM} | | 300 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{°C}$ | 212 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|-----------|--|---------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{jop} | | -40...($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|------------|-------------------------------------|-----------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 4000 | V |
| | | AC Voltage $t_p = 1\text{ min}$ | 2500 | V |
| Creepage distance | | | min. 12,7 | mm |
| Clearance | | | min. 12,7 | mm |
| Comparative Tracking Index | CTI | | > 200 | |

*100 % tested in production



Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|-------|-----|-----|------|
| | | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | |

Inverter Switch

Static

| Parameter | Symbol | Conditions | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | Unit |
|--------------------------------------|--------------|-------------------|--------------|--------------|--------------|-----------|------------|------|--------------|------|------|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{GE} = V_{CE}$ | | | | 0,0052 | 25 | 5,3 | 5,8 | 6,3 | V |
| Collector-emitter saturation voltage | V_{CEsat} | | 15 | | | 150 | 25 150 | 1,58 | 1,93 2,39 | 2,07 | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 1200 | | | 25 | | | 2 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | | 25 | | | 240 | nA |
| Internal gate resistance | r_g | | | | | | | | 5 | | Ω |
| Input capacitance | C_{ies} | $f = 1$ MHz | 0 | 25 | | | 25 | | 8600 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | | 320 | | |

Thermal

| Parameter | Symbol | Conditions | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | Unit |
|-------------------------------------|---------------|---|--------------|--------------|--------------|-----------|------------|-----|------|-----|------|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | phase-change material $\lambda = 3,4$ W/mK | | | | | | | 0,27 | | K/W |

Dynamic

| Parameter | Symbol | Conditions | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | Unit |
|-----------------------------|--------------|--|--------------|--------------|--------------|-----------|------------|-----------------|------------------|-----|------|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 4$ Ω $R_{goff} = 4$ Ω | ±15 | 600 | 150 | 150 | 25 150 | | 213 | | ns |
| Rise time | t_r | | | | | | | | 35 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | | | | 44 | | |
| Fall time | t_f | | | | | | | | 326 | | |
| | | | | | | | | | 410 | | |
| Turn-on energy (per pulse) | E_{on} | $Q_{iFWD} = 15,6$ μC $Q_{iFWD} = 29,2$ μC | | | | | 25 150 | | 12,684 18,795 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 150 | | 8,071 12,853 | | | |



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Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|-------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Inverter Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|--|------|-----|------------------|--|----------------------|------|--|----|
| Forward voltage | V_F | | | 150 | 25 125 150 | | 1,81 1,82 1,80 | 2,05 | | V |
| Reverse leakage current | I_r | | 1200 | | 25 | | | 26 | | μA |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | phase-change material $\lambda = 3,4$ W/mK | | | | | | 0,45 | | K/W |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|--|-----|--------|-----|------|--|--------|--|----|
| Peak recovery current | I_{RRM} | $di/dt = 4656$ A/μs $di/dt = 4044$ A/μs | ±15 | 600 | 150 | 25 | | 143 | | A |
| Reverse recovery time | t_{rr} | | | | | 150 | | 168 | | ns |
| | | | | | | 25 | | 287 | | |
| Recovered charge | Q_r | | | | | 150 | | 465 | | |
| | | | | | | 25 | | 15,555 | | μC |
| Reverse recovered energy | E_{rec} | 150 | | 29,157 | | mWs | | | | |
| | | 25 | | 5,706 | | | | | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | 150 | | 10,813 | | A/μs | | | | |
| | | 25 | | 3267 | | | | | | |
| | | | | | | 1615 | | | | |

Thermistor

| | | | | | | | | | | |
|----------------------------|----------------|--------------------|--|--|-----|-----|------|-----|--|------|
| Rated resistance | R | | | | 25 | | 22 | | | kΩ |
| Deviation of R_{100} | $\Delta_{R/R}$ | $R_{100} = 1486$ Ω | | | 100 | -12 | | +14 | | % |
| Power dissipation | P | | | | 25 | | 200 | | | mW |
| Power dissipation constant | | | | | 25 | | 2 | | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. ±3% | | | 25 | | 3950 | | | K |
| B-value | $B_{(25/100)}$ | Tol. ±3% | | | 25 | | 3998 | | | K |
| Vincotech NTC Reference | | | | | | | | B | | |

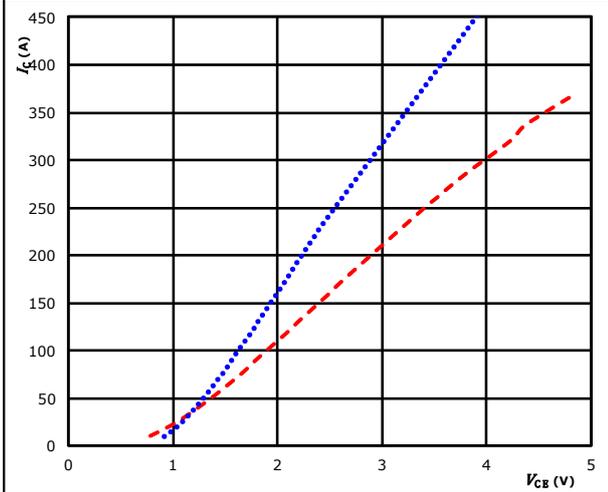


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

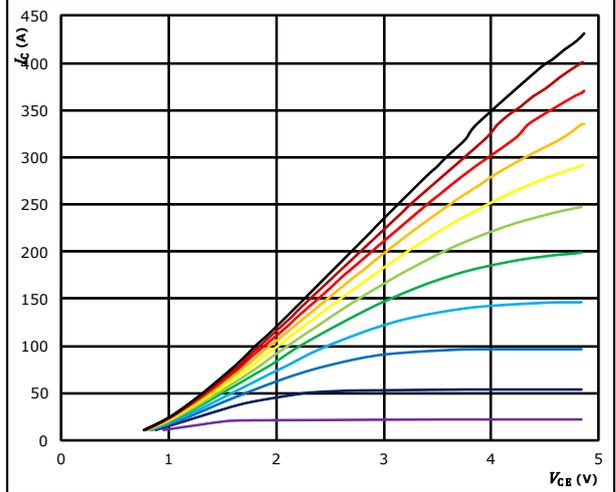


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$ (blue dotted line)
 $150 \text{ } ^\circ C$ (red dashed line)

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

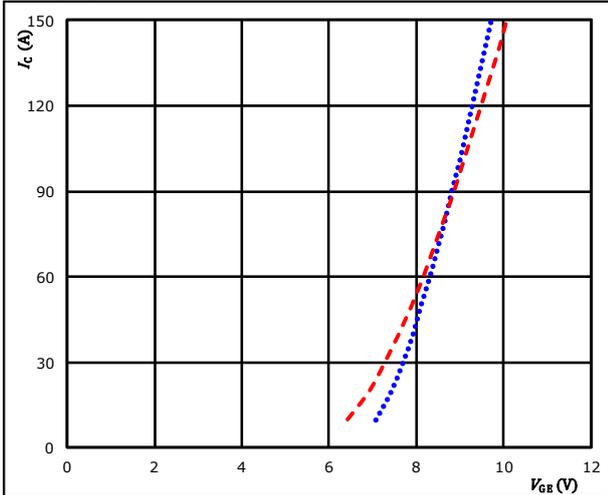


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

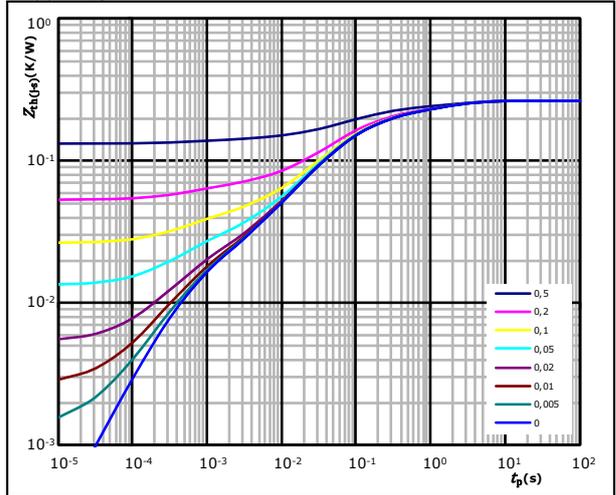


$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ } ^\circ C$ (blue dotted line)
 $150 \text{ } ^\circ C$ (red dashed line)

figure 4. IGBT

Transient Thermal Impedance as function of Pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 0,27 \text{ K/W}$

IGBT thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 5,73E-02 | 1,79E+00 |
| 6,23E-02 | 2,33E-01 |
| 9,18E-02 | 6,24E-02 |
| 3,46E-02 | 2,03E-02 |
| 1,02E-02 | 2,96E-03 |
| 1,19E-02 | 4,61E-04 |

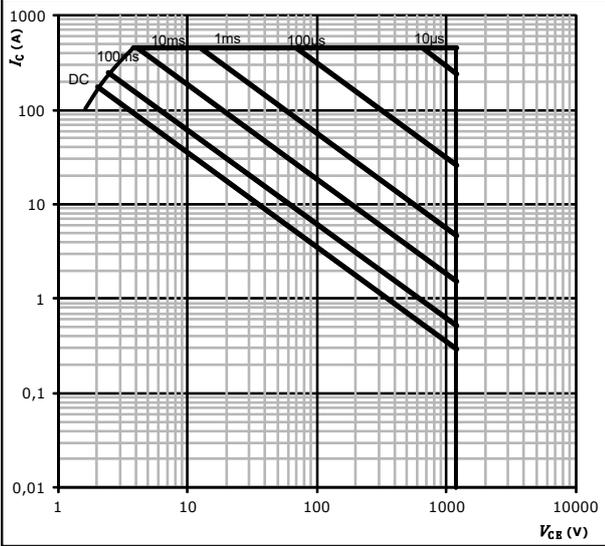


Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$I_C = f(V_{CE})$



At

- $D =$ single pulse
- $T_s = 80$ °C
- $V_{GE} = \pm 15$ V
- $T_j = T_{jmax}$



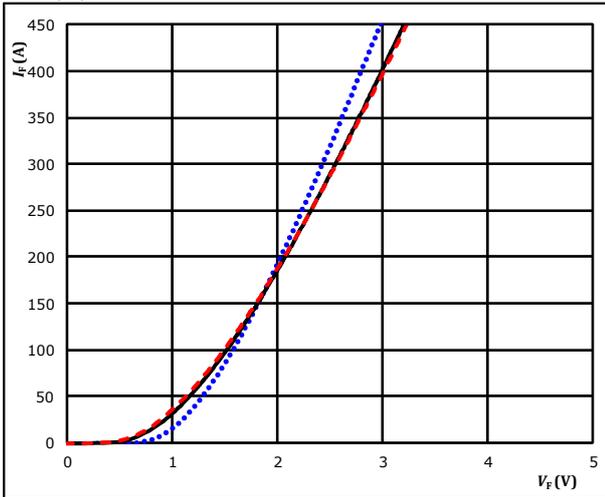
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Inverter Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

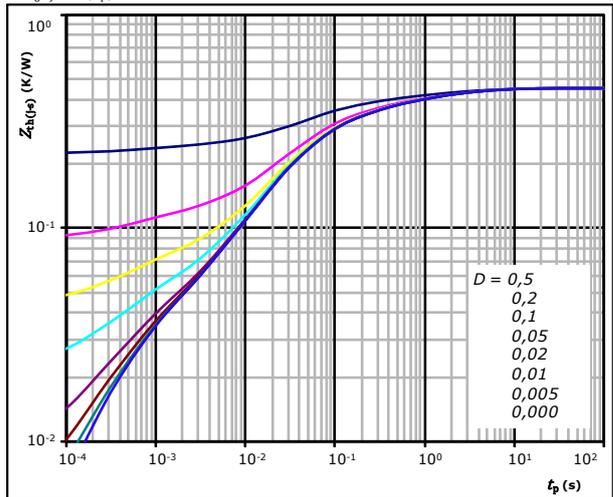


$t_p = 250 \mu s$
 T_j : 25 °C (blue dotted line)
 125 °C (black solid line)
 150 °C (red dashed line)

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,45 \text{ K/W}$

FWD thermal model values

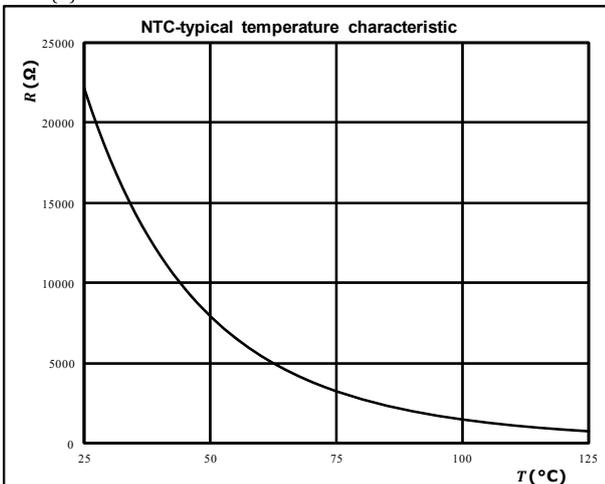
| R (K/W) | τ (s) |
|-----------|------------|
| 3,47E-02 | 4,61E+00 |
| 6,68E-02 | 8,80E-01 |
| 9,40E-02 | 1,70E-01 |
| 1,62E-01 | 4,03E-02 |
| 5,35E-02 | 1,34E-02 |
| 1,57E-02 | 2,01E-03 |
| 2,15E-02 | 4,00E-04 |

Thermistor Characteristics

figure 1. Thermistor

Typical NTC characteristic
as a function of temperature

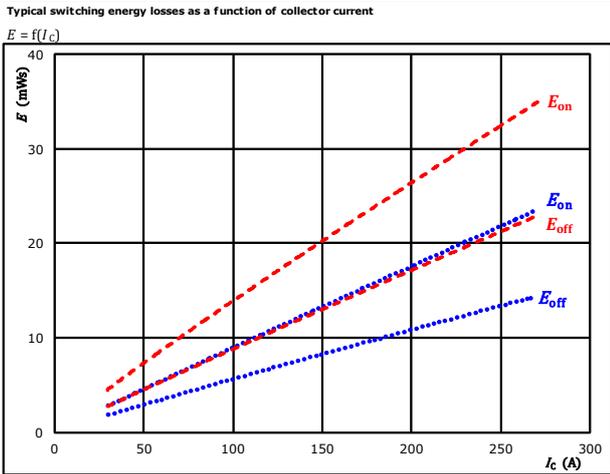
$$R = f(T)$$





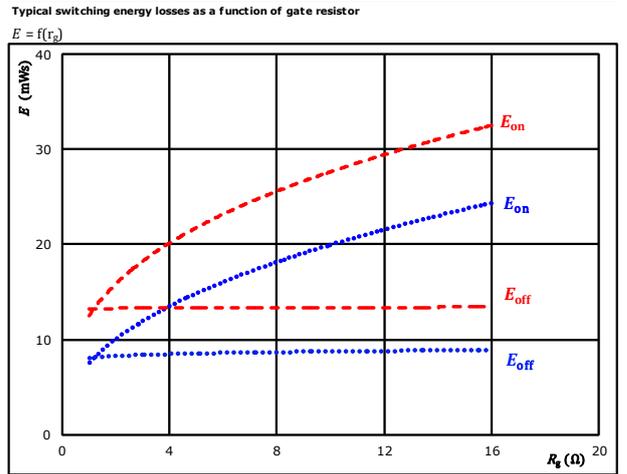
Inverter Switching Characteristics

Figure 1. IGBT



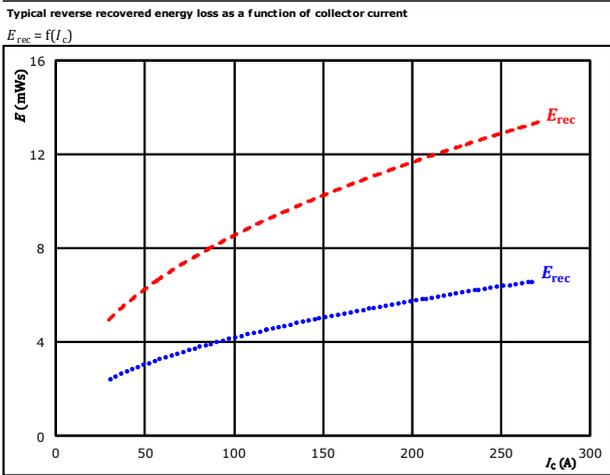
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω
 $T_j: 25$ $^{\circ}\text{C}$ (blue dotted)
 150 $^{\circ}\text{C}$ (red dashed)

Figure 2. IGBT



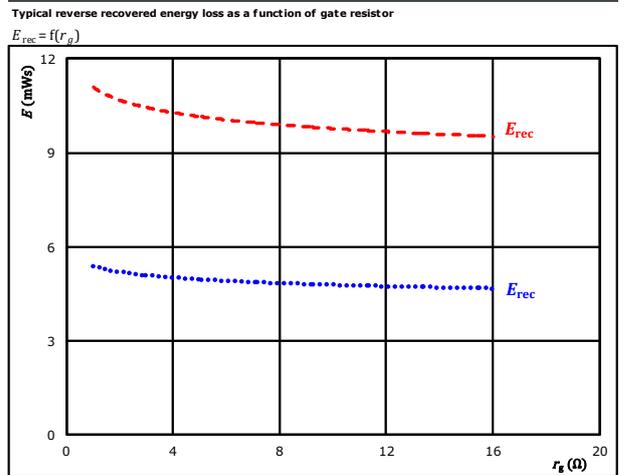
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 150$ A
 $T_j: 25$ $^{\circ}\text{C}$ (blue dotted)
 150 $^{\circ}\text{C}$ (red dashed)

Figure 3. FWD



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ $^{\circ}\text{C}$ (blue dotted)
 150 $^{\circ}\text{C}$ (red dashed)

Figure 4. FWD



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 150$ A
 $T_j: 25$ $^{\circ}\text{C}$ (blue dotted)
 150 $^{\circ}\text{C}$ (red dashed)

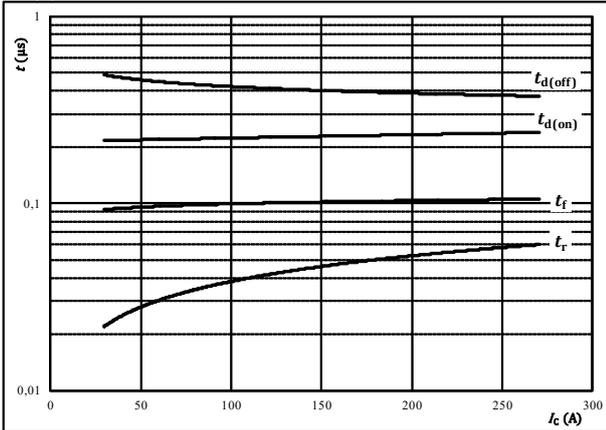


Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



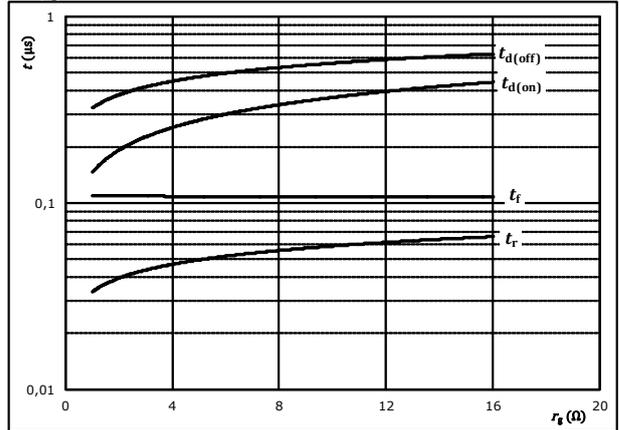
With an inductive load at

| | | |
|--------------|----------|-------------|
| $T_j =$ | 150 | $^{\circ}C$ |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 4 | Ω |
| $R_{goff} =$ | 4 | Ω |

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



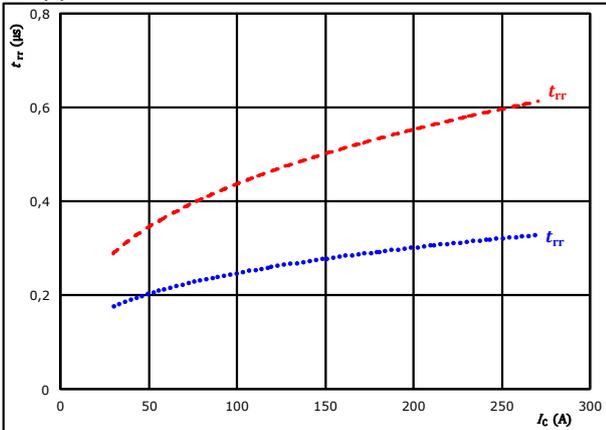
With an inductive load at

| | | |
|------------|----------|-------------|
| $T_j =$ | 150 | $^{\circ}C$ |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 150 | A |

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$



At

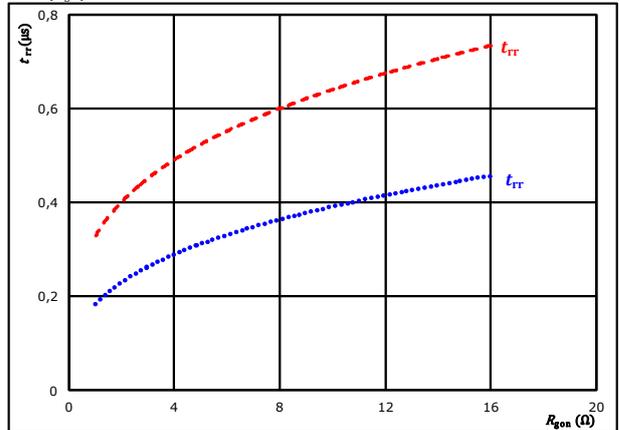
| | | |
|-------------|----------|----------|
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 4 | Ω |

| | | |
|--------|-----------------|-------|
| $T_j:$ | 25 $^{\circ}C$ | |
| | 150 $^{\circ}C$ | ----- |

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

| | | |
|------------|----------|---|
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 150 | A |

| | | |
|--------|-----------------|-------|
| $T_j:$ | 25 $^{\circ}C$ | |
| | 150 $^{\circ}C$ | ----- |



Inverter Switching Characteristics

Figure 9. FWD

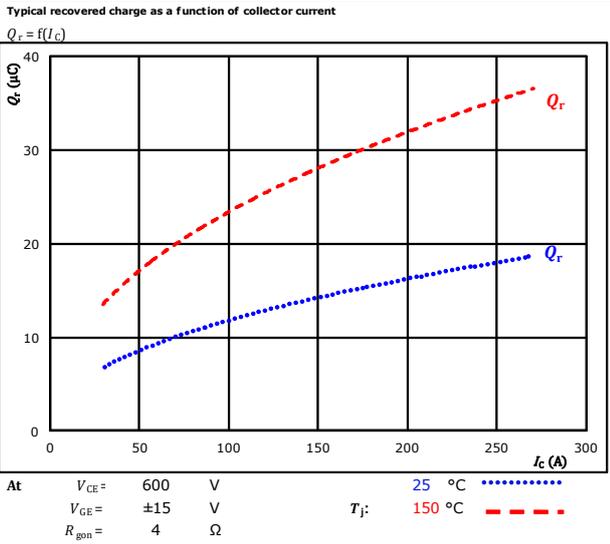


Figure 10. FWD

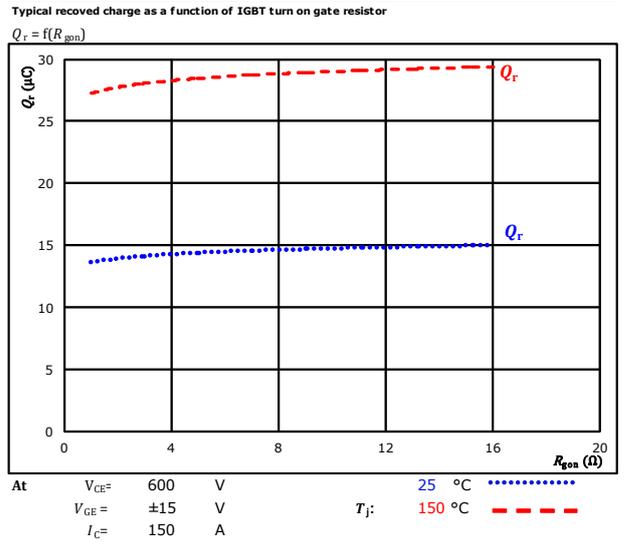


Figure 11. FWD

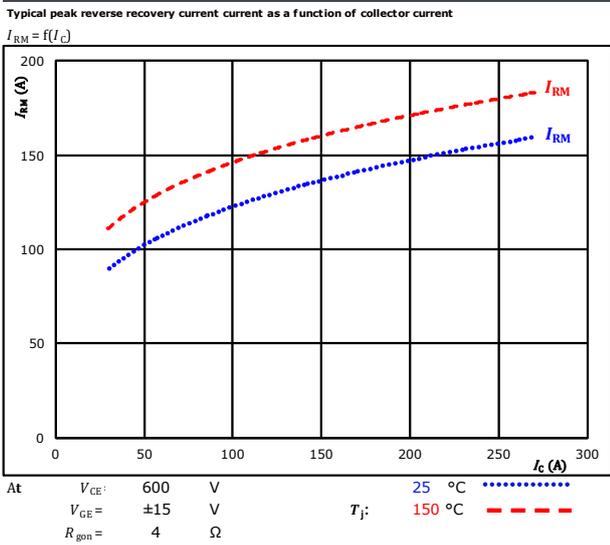
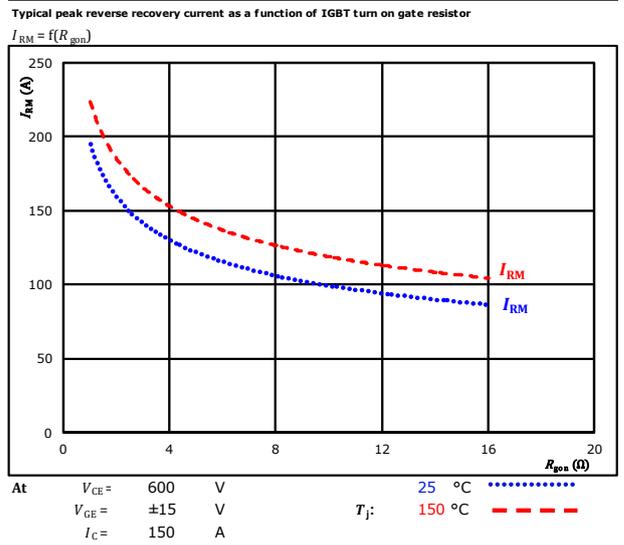


Figure 12. FWD

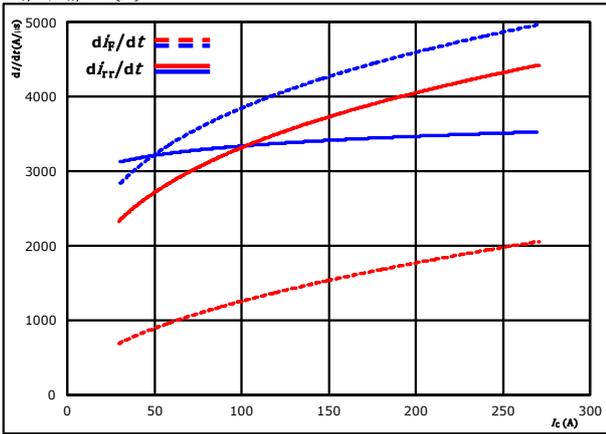




Inverter Switching Characteristics

Figure 13. FWD

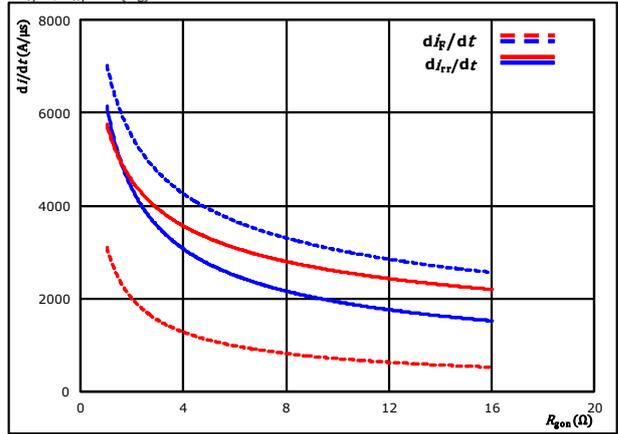
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted blue)
 $V_{GE} = \pm 15$ V $T_j = 150$ °C (dashed red)
 $R_{gon} = 4$ Ω

Figure 14. FWD

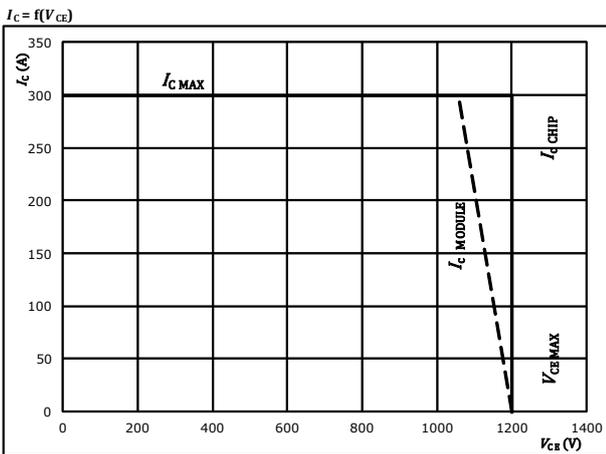
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted blue)
 $V_{GE} = \pm 15$ V $T_j = 150$ °C (dashed red)
 $I_c = 150$ A

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

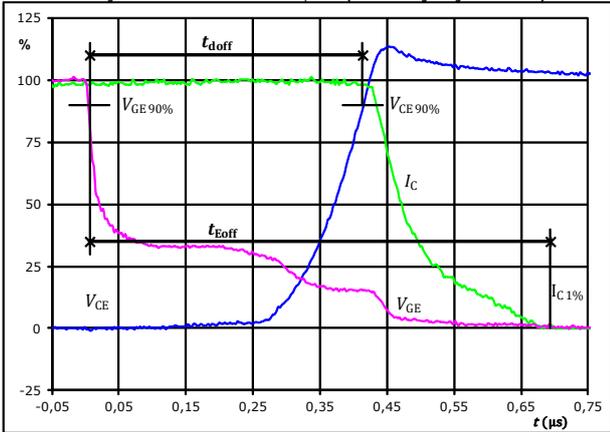


Inverter Switching Definitions

| General conditions | | |
|--------------------|---|------------|
| T_j | = | 150 °C |
| R_{gon} | = | 4 Ω |
| R_{goff} | = | 4 Ω |

Figure 1. IGBT

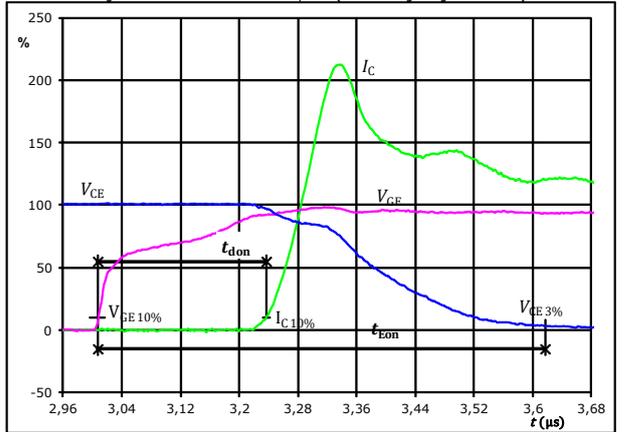
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



| | | |
|-------------------|-------|---------|
| $V_{CE}(0\%) =$ | -15 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 149 | A |
| $t_{doff} =$ | 0,410 | μs |
| $t_{Eoff} =$ | 0,687 | μs |

Figure 2. IGBT

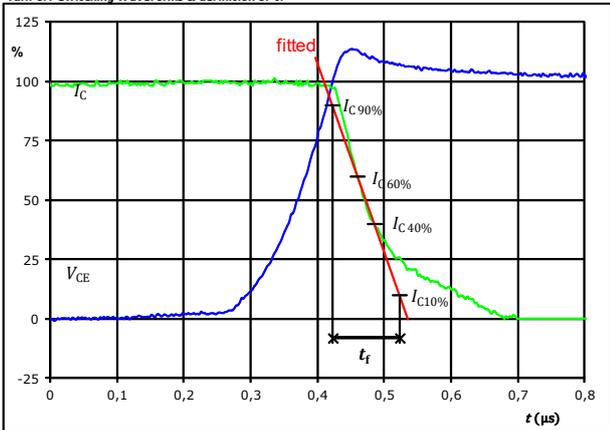
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



| | | |
|-------------------|-------|---------|
| $V_{CE}(0\%) =$ | -15 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 149 | A |
| $t_{don} =$ | 0,229 | μs |
| $t_{Eon} =$ | 0,609 | μs |

Figure 3. IGBT

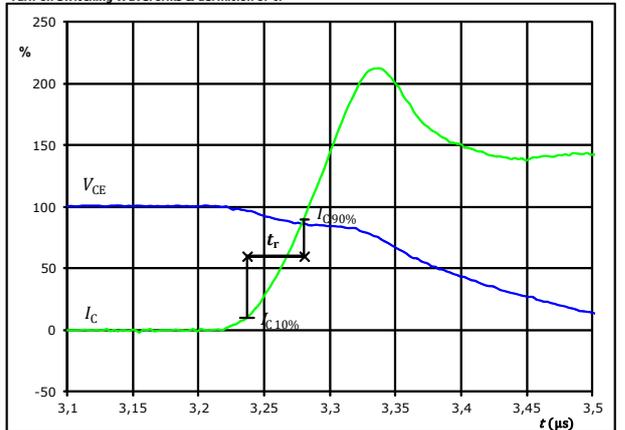
Turn-off Switching Waveforms & definition of t_f



| | | |
|----------------|-------|---------|
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 149 | A |
| $t_f =$ | 0,104 | μs |

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r



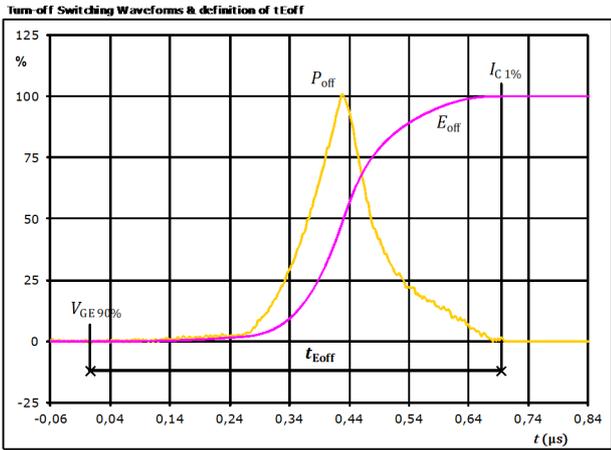
| | | |
|----------------|-------|---------|
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 149 | A |
| $t_r =$ | 0,044 | μs |



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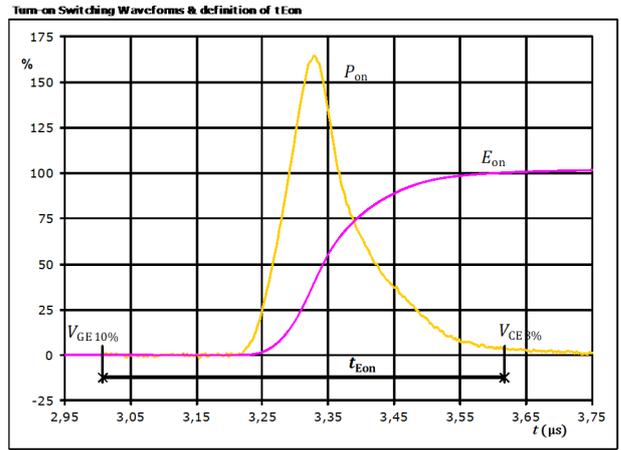
Inverter Switching Characteristics

Figure 5. IGBT



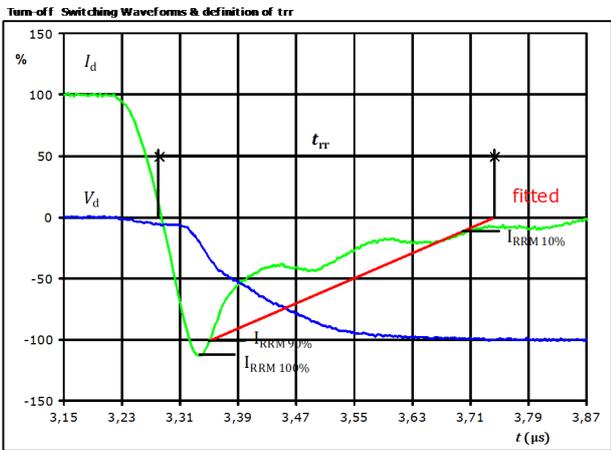
| | | |
|--------------------|--------------|-----------|
| $P_{off}(100\%) =$ | 89,53 | kW |
| $E_{off}(100\%) =$ | 12,85 | mJ |
| $t_{Eoff} =$ | 0,69 | μs |

Figure 6. IGBT



| | | |
|-------------------|--------------|-----------|
| $P_{on}(100\%) =$ | 89,53 | kW |
| $E_{on}(100\%) =$ | 18,80 | mJ |
| $t_{Eon} =$ | 0,61 | μs |

Figure 7. FWD

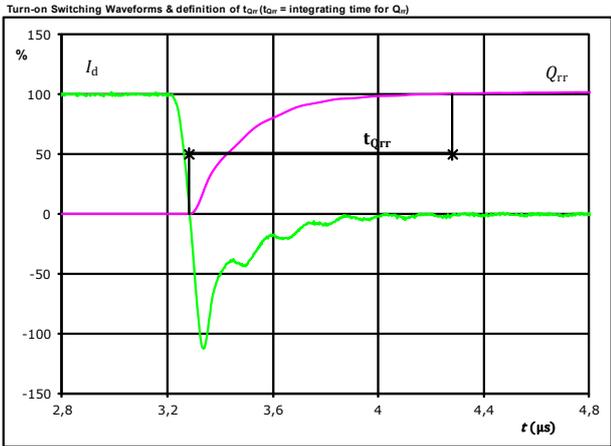


| | | |
|--------------------|--------------|-----------|
| $V_d(100\%) =$ | 600 | V |
| $I_d(100\%) =$ | 149 | A |
| $I_{RRM}(100\%) =$ | -168 | A |
| $t_{rr} =$ | 0,465 | μs |



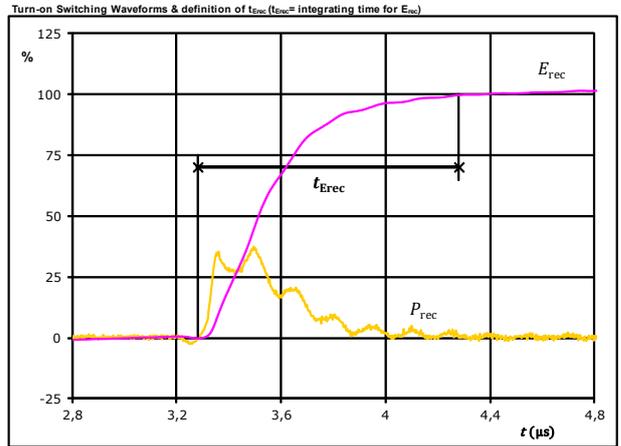
Inverter Switching Characteristics

Figure 8. FWD



| | | |
|-------------------|-------|---------------|
| $I_d(100\%) =$ | 149 | A |
| $Q_{rr}(100\%) =$ | 29,16 | μC |
| $t_{Qrr} =$ | 1,00 | μs |

Figure 9. FWD



| | | |
|--------------------|-------|---------------|
| $P_{rec}(100\%) =$ | 89,53 | kW |
| $E_{rec}(100\%) =$ | 10,81 | mJ |
| $t_{Erec} =$ | 1,00 | μs |



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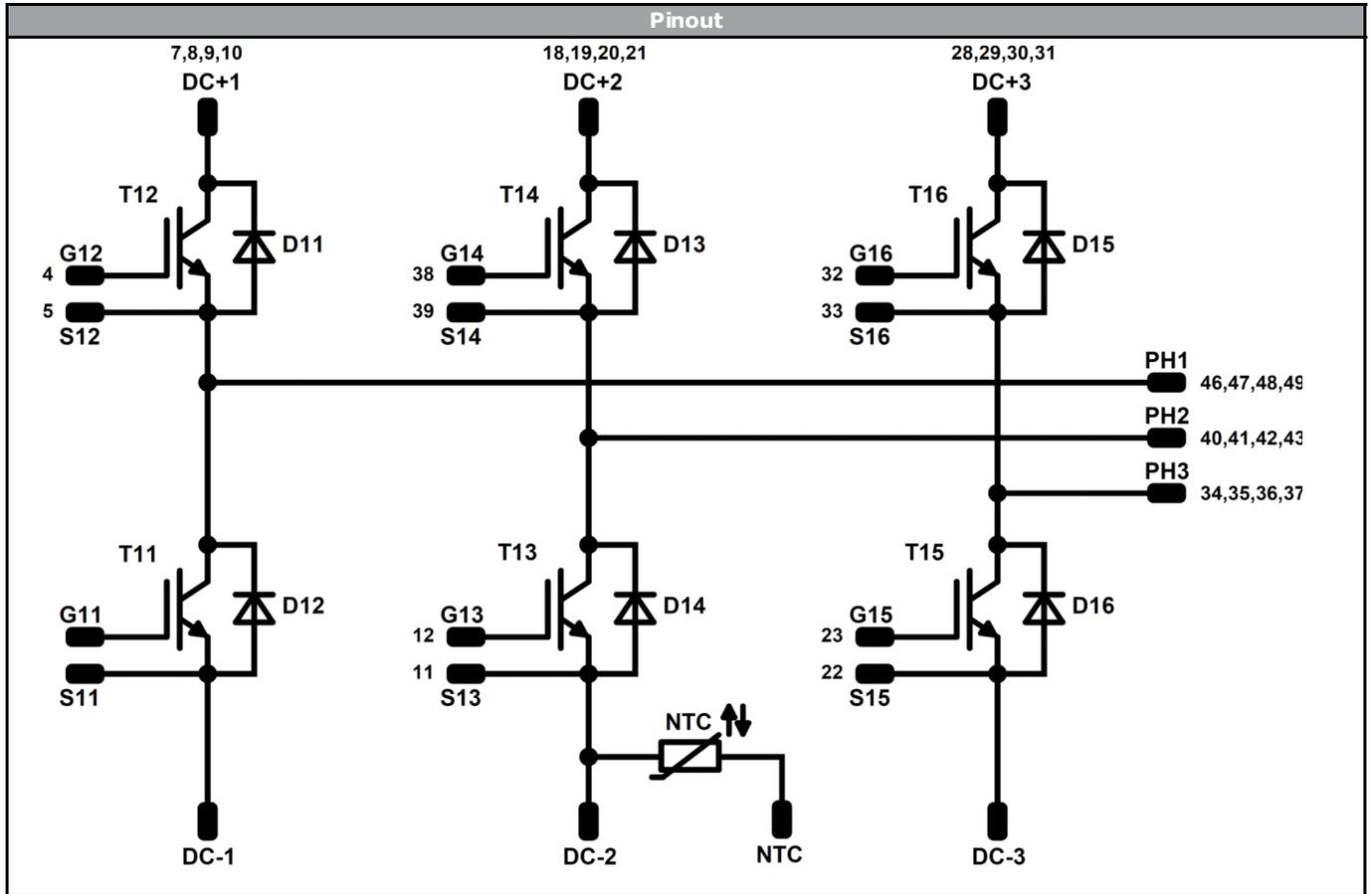
| Ordering Code & Marking | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|--|---------------------------|------------|------------------------------|-----------|-------|--------|------|------|--|-----------|----------|-----|--------|---------------------------|--|------|--------|-------|------|----------|------------|--------|-----------|--|--|------------|---------|-------|------|------|--|--|
| Version | | | Ordering Code | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| without thermal paste 17 mm housing with press-fit pins | | | 30-P2126PA150SC-L280F09Y | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| with thermal paste 17 mm housing with press-fit pins | | | 30-P2126PA150SC-L280F09Y-/3/ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th rowspan="3">Text</th> <th colspan="2">Name</th> <th>Date code</th> <th>UL & VIN</th> <th>Lot</th> <th>Serial</th> </tr> <tr> <td colspan="2">NN-NNNNNNNNNNNNNN-TTTTTWW</td> <td>WWYY</td> <td>UL VIN</td> <td>LLLLL</td> <td>SSSS</td> </tr> <tr> <th>Type&Ver</th> <th>Lot number</th> <th>Serial</th> <th>Date code</th> <td></td> <td></td> </tr> </thead> <tbody> <tr> <td>Datamatrix</td> <td>TTTTTWW</td> <td>LLLLL</td> <td>SSSS</td> <td>WWYY</td> <td></td> <td></td> </tr> </tbody> </table> | | | | | | | Text | Name | | Date code | UL & VIN | Lot | Serial | NN-NNNNNNNNNNNNNN-TTTTTWW | | WWYY | UL VIN | LLLLL | SSSS | Type&Ver | Lot number | Serial | Date code | | | Datamatrix | TTTTTWW | LLLLL | SSSS | WWYY | | |
| Text | Name | | Date code | UL & VIN | Lot | Serial | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | NN-NNNNNNNNNNNNNN-TTTTTWW | | WWYY | UL VIN | LLLLL | SSSS | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | Type&Ver | Lot number | Serial | Date code | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Datamatrix | TTTTTWW | LLLLL | SSSS | WWYY | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| Pin table | | | |
|-----------|------|------|----------|
| Pin | X | Y | Function |
| 1 | 0,9 | 0 | S11 |
| 2 | 0,9 | 3 | G11 |
| 3 | 3,9 | 0 | DC-1 |
| 4 | 3,9 | 2,7 | DC-1 |
| 5 | 3,9 | 5,4 | DC-1 |
| 6 | 6,6 | 0 | DC-1 |
| 7 | 15,2 | 0 | DC+1 |
| 8 | 15,2 | 2,7 | DC+1 |
| 9 | 17,9 | 0 | DC+1 |
| 10 | 17,9 | 2,7 | DC+1 |
| 11 | 26,2 | 0 | S13 |
| 12 | 26,2 | 3 | G13 |
| 13 | 29,2 | 0 | DC-2 |
| 14 | 29,2 | 2,7 | DC-2 |
| 15 | 29,2 | 5,4 | DC-2 |
| 16 | 31,9 | 0 | DC-2 |
| 17 | 32,2 | 4,05 | NTC |
| 18 | 40,5 | 0 | DC+2 |
| 19 | 40,5 | 2,7 | DC+2 |
| 20 | 43,2 | 0 | DC+2 |
| 21 | 43,2 | 2,7 | DC+2 |
| 22 | 51,5 | 0 | S15 |
| 23 | 51,5 | 3 | G15 |
| 24 | 54,5 | 0 | DC-3 |
| 25 | 54,5 | 2,7 | DC-3 |
| 26 | 54,5 | 5,4 | DC-3 |
| 27 | 57,2 | 0 | DC-3 |
| 28 | 65,8 | 0 | DC+3 |
| 29 | 65,8 | 2,7 | DC+3 |
| 30 | 68,5 | 0 | DC+3 |
| 31 | 68,5 | 2,7 | DC+3 |
| 32 | 64,7 | 36 | G16 |
| 33 | 61,7 | 36 | S16 |
| 34 | 58,7 | 36 | PH3 |
| 35 | 56 | 36 | PH3 |
| 36 | 53,3 | 36 | PH3 |
| 37 | 50,6 | 36 | PH3 |
| 38 | 39,4 | 36 | G14 |
| 39 | 36,4 | 36 | S14 |
| 40 | 33,4 | 36 | PH2 |
| 41 | 30,7 | 36 | PH2 |
| 42 | 28 | 36 | PH2 |
| 43 | 25,3 | 36 | PH2 |
| 44 | 14,1 | 36 | G12 |
| 45 | 11,1 | 36 | S12 |
| 46 | 8,1 | 36 | PH1 |
| 47 | 5,4 | 36 | PH1 |
| 48 | 2,7 | 36 | PH1 |
| 49 | 0 | 36 | PH1 |

Outline



Vincotech



| Identification | | | | | |
|------------------------------|-----------|---------|---------|-----------------|---------|
| ID | Component | Voltage | Current | Function | Comment |
| T11, T12, T13, T14, T15, T16 | IGBT | 1200 V | 150 A | Inverter Switch | |
| D11, D12, D13, D14, D15, D16 | FWD | 1200 V | 150 A | Inverter Diode | |
| NTC | NTC | | | Thermistor | |



Vincotech

| Packaging instruction | | | |
|--------------------------------------|------|----------|-------------|
| Standard packaging quantity (SPQ) 36 | >SPQ | Standard | <SPQ Sample |

| Handling instruction |
|---|
| Handling instructions for <i>flow 2</i> packages see vincotech.com website. |

| Package data |
|--|
| Package data for <i>flow 2</i> packages see vincotech.com website. |

| UL recognition and file number |
|---|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.: | Date: | Modification: | Pages |
|--------------------------------|--------------|---|-------|
| 30-P2126PA150SC-L280F09Y-D2-14 | 17 Aug. 2017 | Inverter diode characteristic values updated, SPQ changed | All |
| 30-P2126PA150SC-L280F09Y-D3-14 | 1 Jul. 2020 | Outline changed | 1, 15 |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.